505806185 12/05/2019

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

CONVEYING PARTY DATA

Name	Execution Date
AMITAVA MAJUMDAR	11/12/2019
RADHAKRISHNA KOTTI	11/12/2019
PATRICK DANIEL WHITE	11/12/2019
PAVAN REDDY K AELLA	11/12/2019
RAJESH KAMANA	11/12/2019

RECEIVING PARTY DATA

Name:	MICRON TECHNOLOGY, INC.
Street Address:	800 SOUTH FEDERAL WAY
City:	BOISE
State/Country:	IDAHO
Postal Code:	83716-9632

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16684533

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Correspondent Name: HOLLAND & HART LLP

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ATTORNEY DOCKET NUMBER: P469 (88231.1431)	
NAME OF SUBMITTER:	MICHAEL L. DRAPKIN
SIGNATURE: /Michael L. Drapkin/	
DATE SIGNED:	12/05/2019

Total Attachments: 7

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ASSIGNMENT

WHEREAS, WE,

- 1. **Amitava Majumdar**, a citizen of India, having a mailing address located at 8000 South Federal Way, Boise, Idaho 83716-9632, and a resident of Boise, ID,
- 2. **Radhakrishna Kotti**, a citizen of India, having a mailing address located at 8000 South Federal Way, Boise, Idaho 83716-9632, and a resident of Boise, ID,
- 3. **Patrick Daniel White**, a citizen of the United States of America, having a mailing address located at 8000 South Federal Way, Boise, Idaho 83716-9632, and a resident of Kuna, ID,
- 4. **Pavan Reddy K Aella**, a citizen of the United States of America, having a mailing address located at 8000 South Federal Way, Boise, Idaho 83716-9632, and a resident of Eagle, ID,
- 5. **Rajesh Kamana**, a citizen of India, having a mailing address located at 8000 South Federal Way, Boise, Idaho 83716-9632, and a resident of Boise, ID,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to LEAKAGE SOURCE DETECTION (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, MICRON TECHNOLOGY, INC. (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 8000 South Federal Way, Boise, Idaho 83716-9632, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE,

its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

PATENT Client Ref. No. 2019-0695.00/US Page 3 of 7

Witnessed By:

Signature:

Printed Name:

Printed Name:

Tames Wholes

Printed Name:

Printed Name:

Tames Wholes

Tames Wholes

IN TESTIM	IONY WHEREOF, I have hereunto	set my hand this	12 day of Nov, 20 19.
		J. P. Knish.	
	R	adhakrishna Ko	tti
Witnessed F	₃y:		
Signature:	aublu	Printed Name:	Richard Skernatt
Signature:	41/	Printed Name:	James Wheele

IN TESTIMONY WHEREOF, I have hereunto set my hand this 12 day of Nov., 2019.

Patrick Daniel White

Witnessed By:

Signature:

Printed Name: Jane Wheeler

Witnessed By:

Signature:

Printed Name: Kelya Yastrebenetsky

Printed Name: TETASWI NDUKURI

IN TESTIMONY WHEREOF, I have hereunto set my hand this 12 day of Nov., 2019.

IN TESTIMONY WHEREOF, I have hereunto set my hand this 12 day of 2019.

Witnessed By:

Signature: Liebert Printed Name: Lichard Skerratt

Signature: Printed Name: James Wheeler

PATENT REEL: 051194 FRAME: 0440

RECORDED: 12/05/2019